



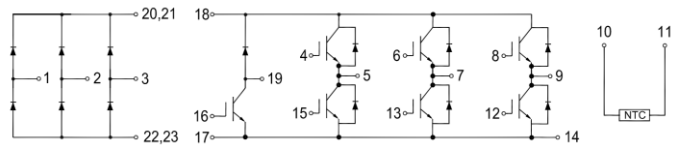
# GK35PI60T5H-T4

## IGBT Module

Preliminary Data

### Features:

- Non Punch Through (NPT) Technology
- Short Circuit Rated > 10μs
- Low Saturation Voltage
- Low Switching Loss
- 100% RBSOA Tested (2xIc)
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement



### Applications:

- Industrial Inverters
- Servo Applications

### IGBT, Inverter

**Maximum Rated Values** ( $T_C=25^{\circ}\text{C}$  unless otherwise specified)

$V_{CES}$	Collector-Emitter Blocking Voltage		600	V
$V_{GES}$	Gate-Emitter Voltage		$\pm 20$	V
$I_C$	Continuous Collector Current	$T_C = 80^{\circ}\text{C}$	35	A
		$T_C = 25^{\circ}\text{C}$	50	A
$I_{CM}$	Peak Collector Current Repetitive	$T_J = 150^{\circ}\text{C}$	70	A
tsc	Short Circuit Withstand Time		>10	μs
$P_D$	Maximum Power Dissipation per IGBT	$T_C = 25^{\circ}\text{C}$ $T_{Jmax}=150^{\circ}\text{C}$	190	W



## Electrical Characteristics of IGBT ( $T_C=25^\circ\text{C}$ unless otherwise specified)

### Static Characteristics

Symbol	Description	Conditions	Min	Typ	Max	Unit
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C = 1 \text{ mA}, V_{CE} = V_{GE}$	3.0	4.5	5.0	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 35\text{A}, V_{GE} = 15\text{V}$	$T_J = 25^\circ\text{C}$	1.80	2.10	V
			$T_J = 125^\circ\text{C}$	2.00		V
$I_{CES}$	Collector-Emitter Leakage Current	$V_{GE} = 0\text{V}, V_{CE} = V_{CES}, T_J = 25^\circ\text{C}$			1	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE} = \pm 20\text{V}, V_{CE} = 0\text{V}, T_J = 25^\circ\text{C}$			200	nA
$C_{ies}$	Input Capacitance	$V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$		1.90		nF
$C_{res}$	Output Capacitance			0.30		nF

### Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	$V_{CC} = 300\text{V}, I_C = 35\text{A}, R_G = 20\Omega, V_{GE} = \pm 15\text{V},$ Inductive Load	$T_J = 25^\circ\text{C}$	70		ns
			$T_J = 125^\circ\text{C}$	60		
$t_r$	Rise Time		$T_J = 25^\circ\text{C}$	50		ns
			$T_J = 125^\circ\text{C}$	50		
$t_{d(off)}$	Turn-off Delay Time		$T_J = 25^\circ\text{C}$	128		ns
			$T_J = 125^\circ\text{C}$	130		
$t_f$	Fall Time		$T_J = 25^\circ\text{C}$	90		ns
			$T_J = 125^\circ\text{C}$	110		
$E_{on}$	Turn-on Switching Loss		$T_J = 25^\circ\text{C}$	0.29		mJ
			$T_J = 125^\circ\text{C}$	0.42		
$E_{off}$	Turn-off Switching Loss	$T_J = 25^\circ\text{C}$	0.31		mJ	
		$T_J = 125^\circ\text{C}$	0.50			
$Q_g$	Total Gate Charge	$T_J = 25^\circ\text{C}$	160		nC	
RBSOA	Reverse Bias Safe Operation Area	$I_C=70\text{A}, V_{CC}=480\text{V}, V_p=600\text{V}, R_G = 20\Omega, V_{GE}=\pm 15\text{V to } 0\text{V}, T_J = 150^\circ\text{C}$	Trapezoid			
SCSOA	Short Circuit Safe Operation Area	$V_{CC} = 300\text{V}, V_{GE} = 15\text{V}, T_J = 150^\circ\text{C}$	10			$\mu\text{s}$
$R_{\theta JC}$	IGBT Thermal Resistance: Junction-To-Case				0.67	$^\circ\text{C/W}$



## Diode, Inverter

### Maximum Rated Values ( $T_C=25^\circ\text{C}$ unless otherwise specified)

$V_{RRM}$	Repetitive Peak Reverse Voltage	600	V
$I_F$	Diode Continuous Forward Current	35	A
$I_{FM}$	Repetitive Peak Forward Current	70	A

### Electrical Characteristics of FWD ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Description	Conditions		Min	Typ	Max	Unit
$V_{FM}$	Forward Voltage	$I_F = 35\text{A}$ , $V_{GE} = 0\text{V}$	$T_J = 25^\circ\text{C}$		1.40	1.60	V
			$T_J = 125^\circ\text{C}$		1.40		
$I_{rr}$	Peak Reverse Recovery Current		$T_J = 25^\circ\text{C}$		18		A
			$T_J = 125^\circ\text{C}$		22		
$Q_{rr}$	Reverse Recovery Charge	$I_F = 35\text{A}$ , $di/dt = 960\text{A}/\mu\text{s}$ , $V_{rr} = 300\text{V}$ , $V_{GE} = -15\text{V}$	$T_J = 25^\circ\text{C}$		2.76		$\mu\text{C}$
			$T_J = 125^\circ\text{C}$		2.43		
$E_{rec}$	Reverse Recovery Energy		$T_J = 25^\circ\text{C}$		0.14		mJ
			$T_J = 125^\circ\text{C}$		0.34		
$R_{\theta JC}$	Diode Thermal Resistance: Junction-To-Case					1.63	$^\circ\text{C}/\text{W}$

## IGBT, Brake-Chopper

### Maximum Rated Values ( $T_C=25^\circ\text{C}$ unless otherwise specified)

$V_{CES}$	Collector-Emitter Blocking Voltage		600	V
$V_{GES}$	Gate-Emitter Voltage		$\pm 20$	V
$I_C$	Continuous Collector Current	$T_C = 80^\circ\text{C}$	35	A
		$T_C = 25^\circ\text{C}$	70	A
$I_{CM}$	Peak Collector Current Repetitive	$T_J = 150^\circ\text{C}$	70	A
$t_{SC}$	Short Circuit Withstand Time		$>10$	$\mu\text{s}$
$P_D$	Maximum Power Dissipation (IGBT)	$T_C = 25^\circ\text{C}$ $T_{Jmax} = 150^\circ\text{C}$	260	W



## Electrical Characteristics of IGBT ( $T_C=25^\circ\text{C}$ unless otherwise specified)

### Static Characteristics

Symbol	Description	Conditions	Min	Typ	Max	Unit
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C = 1 \text{ mA}, V_{CE} = V_{GE}$	3.0	4.5	5.0	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 35\text{A}, V_{GE} = 15\text{V}$	$T_J = 25^\circ\text{C}$	1.80	2.10	V
			$T_J = 125^\circ\text{C}$	2.00		V
$I_{CES}$	Collector-Emitter Leakage Current	$V_{GE} = 0\text{V}, V_{CE} = V_{CES}, T_J = 25^\circ\text{C}$			1	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE} = \pm 20\text{V}, V_{CE} = 0\text{V}, T_J = 25^\circ\text{C}$			200	nA
$C_{ies}$	Input Capacitance	$V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$		1.90		nF
$C_{oes}$	Output Capacitance			0.30		nF

### Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	$V_{CC} = 300\text{V}, I_C = 35\text{A}, R_G = 20\Omega, V_{GE} = \pm 15\text{V},$ Inductive Load	$T_J = 25^\circ\text{C}$	70		ns
			$T_J = 125^\circ\text{C}$	60		
$t_r$	Rise Time		$T_J = 25^\circ\text{C}$	50		ns
			$T_J = 125^\circ\text{C}$	50		
$t_{d(off)}$	Turn-off Delay Time		$T_J = 25^\circ\text{C}$	128		ns
			$T_J = 125^\circ\text{C}$	130		
$t_f$	Fall Time		$T_J = 25^\circ\text{C}$	90		ns
			$T_J = 125^\circ\text{C}$	110		
$E_{on}$	Turn-on Switching Loss		$T_J = 25^\circ\text{C}$	0.29		mJ
			$T_J = 125^\circ\text{C}$	0.42		
$E_{off}$	Turn-off Switching Loss	$T_J = 25^\circ\text{C}$	0.31		mJ	
		$T_J = 125^\circ\text{C}$	0.50			
$Q_g$	Total Gate Charge	$T_J = 25^\circ\text{C}$	160		nC	
RBSOA	Reverse Bias Safe Operation Area	$I_C=70\text{A}, V_{CC}=480\text{V}, V_p=600\text{V}, R_G = 20\Omega, V_{GE}=\pm 15\text{V to } 0\text{V}, T_J = 150^\circ\text{C}$	Trapezoid			
SCSOA	Short Circuit Safe Operation Area	$V_{CC} = 300\text{V}, V_{GE} = 15\text{V}, T_J = 150^\circ\text{C}$	10			$\mu\text{s}$
$R_{\theta JC}$	IGBT Thermal Resistance: Junction-To-Case				0.67	$^\circ\text{C/W}$



**Diode, Brake-Chopper**  
**Maximum Rated Values (T<sub>C</sub>=25°C unless otherwise specified)**

V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	600	V
I <sub>F</sub>	Diode Continuous Forward Current	35	A
I <sub>FM</sub>	Repetitive Peak Forward Current	70	A

**Electrical Characteristics of FWD (T<sub>C</sub>=25°C unless otherwise specified)**

Symbol	Description	Conditions		Min	Typ	Max	Unit
V <sub>FM</sub>	Forward Voltage	I <sub>F</sub> = 35 A, V <sub>GE</sub> = 0V	T <sub>J</sub> = 25°C		1.40	1.60	V
			T <sub>J</sub> = 125°C		1.40		
I <sub>rr</sub>	Peak Reverse Recovery Current		T <sub>J</sub> = 25°C		30		A
			T <sub>J</sub> = 125°C		35		
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> = 35A, di/dt = 960A/μs, V <sub>rr</sub> = 300V, V <sub>GE</sub> = -15V	T <sub>J</sub> = 25°C		1.51		μC
			T <sub>J</sub> = 125°C		2.43		
E <sub>rec</sub>	Reverse Recovery Energy		T <sub>J</sub> = 25°C		0.14		mJ
			T <sub>J</sub> = 125°C		0.34		
R <sub>θJC</sub>	Diode Thermal Resistance: Junction-To-Case					1.63	°C/W

**Diode, Rectifier**  
**Maximum Rated Values (T<sub>C</sub>=25°C unless otherwise specified)**

V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	T <sub>J</sub> = 25°C	1200	V
I <sub>FRMSM</sub>	Maximum RMS Forward Current per Chip	T <sub>J</sub> = 80°C	35	A
I <sub>RMSM</sub>	Maximum RMS Current at Rectifier Output	T <sub>J</sub> = 80°C	35	A
I <sub>FSM</sub>	Surge Current @t <sub>p</sub> =10 ms	T <sub>J</sub> = 25°C	300	A
		T <sub>J</sub> = 150°C	450	
I <sup>2</sup> t	I <sup>2</sup> t - value	T <sub>J</sub> = 25°C	450	A <sup>2</sup> s
		T <sub>J</sub> = 150°C	300	



## Electrical Characteristics of Diode (T<sub>C</sub>=25°C unless otherwise specified)

V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 35 A,	T <sub>J</sub> =25°C	1.10		V
			T <sub>J</sub> =150°C	1.00		
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =1200V	T <sub>J</sub> =25°C		1	mA
R <sub>θJC</sub>	Diode Thermal Resistance: Junction-To-Case				0.89	°C/W

## Internal NTC-Thermistor Characteristics

Symbol	Description		Min.	Typ.	Max.	Units.
R <sub>25</sub>	Rated Resistance	T <sub>C</sub> =25°C		5		kΩ
ΔR/R	Deviation of R100	T <sub>C</sub> =100°C, R <sub>100</sub> =481Ω	-5		5	%
P <sub>25</sub>	Power Dissipation	T <sub>C</sub> =25°C			10	mW
B <sub>25/50</sub>	B-Value	$R_2=R_{25} \exp[B_{25/50}(1/T_2-1/(298.15K))]$		3380		K
B <sub>25/80</sub>	B-Value	$R_2=R_{25} \exp[B_{25/80}(1/T_2-1/(298.15K))]$		3440		K
B <sub>25/100</sub>	B-Value	$R_2=R_{25} \exp[B_{25/100}(1/T_2-1/(298.15K))]$		3545		K

## Module

Symbol	Description		Min	Typ	Max	Unit
V <sub>iso</sub>	Isolation Voltage (All Terminals Shorted)	RMS, f=50Hz, 1minute	2500			V
T <sub>J</sub>	Maximum Junction Temperature				150	°C
T <sub>JOP</sub>	Maximum Operating Junction Temperature Range		-40		+150	°C
T <sub>stg</sub>	Storage Temperature		-40		+125	°C
R <sub>θCS</sub>	Case-To-Sink Thermally (Conductive Grease Applied)				0.03	°C/W
M	Mounting Torque for Module Mounting	Screw M5--Mounting according to valid application note	3.0		5.0	N·m
G	Weight			190		g

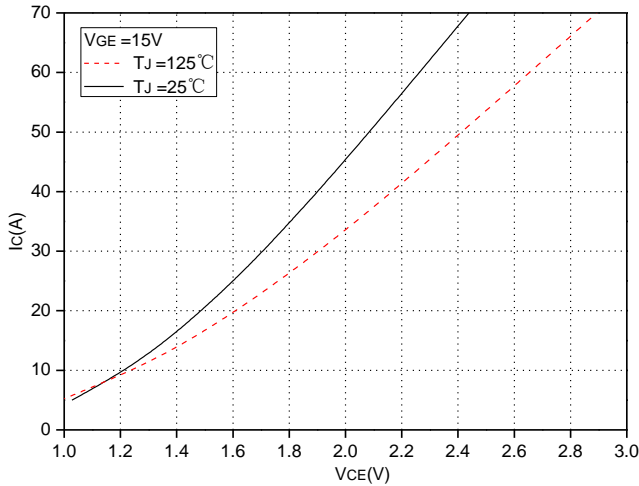


Fig.1 Typical Saturation Voltage Characteristics

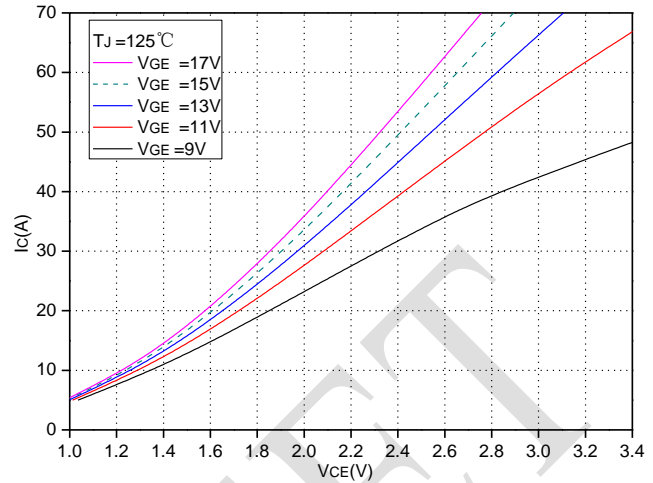


Fig.2 Typical Output Characteristics

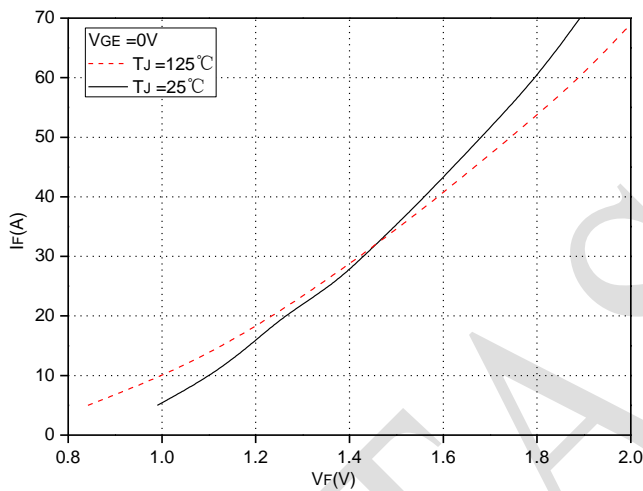


Fig.3 Forward Characteristics of FWD

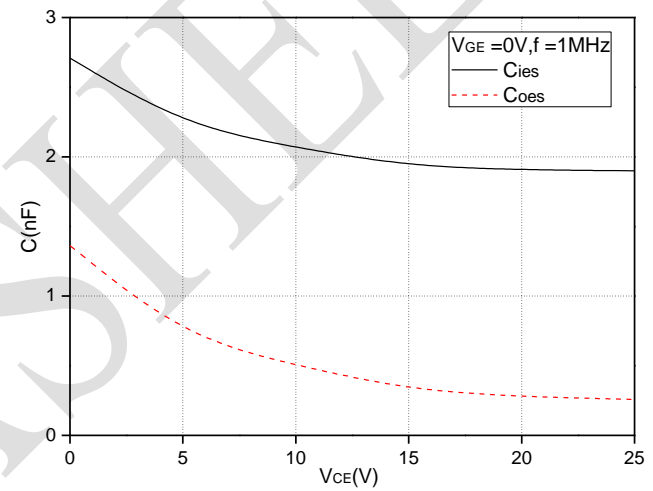


Fig.4 Capacitance Characteristics

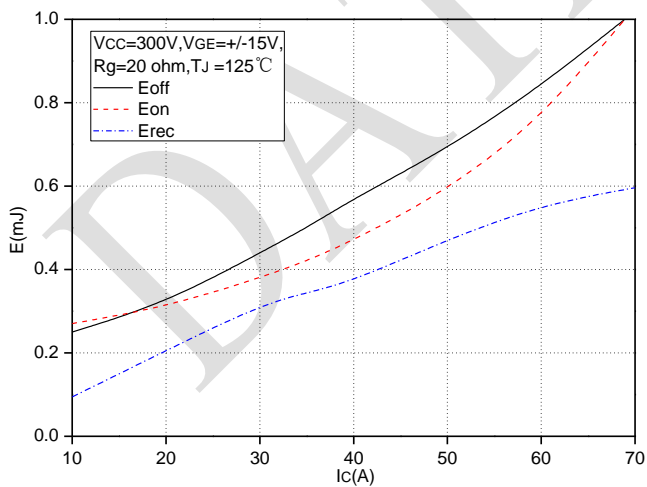


Fig.5 Typical Switching Loss vs. Collector Current

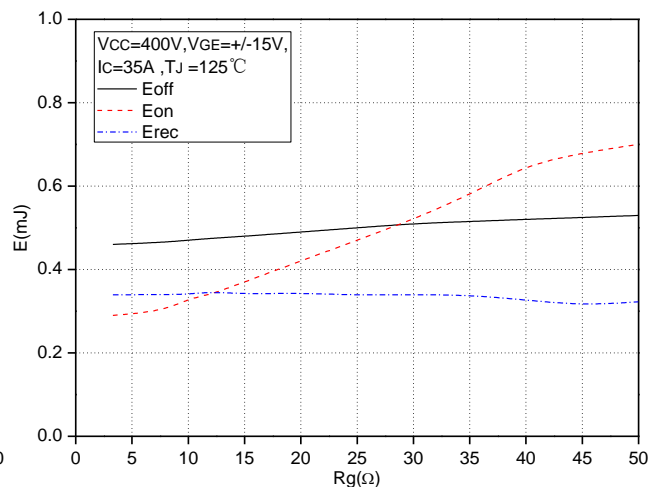
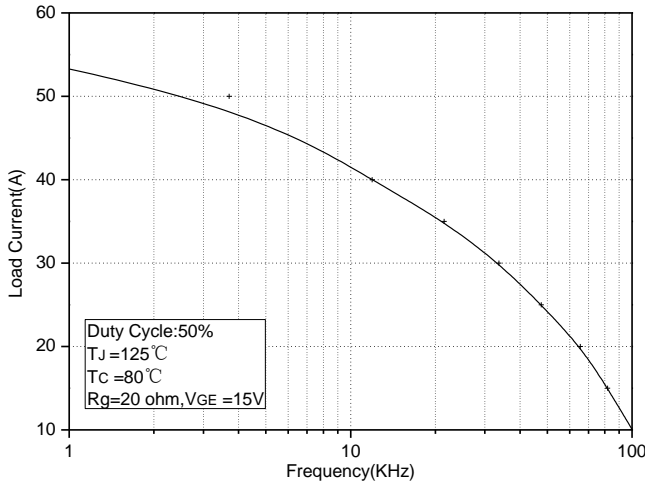
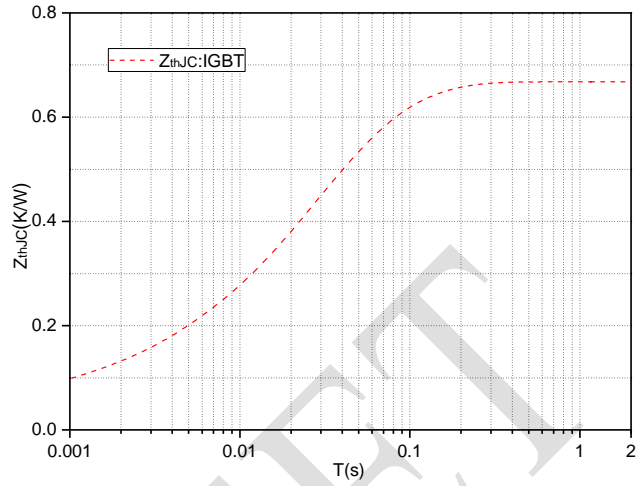


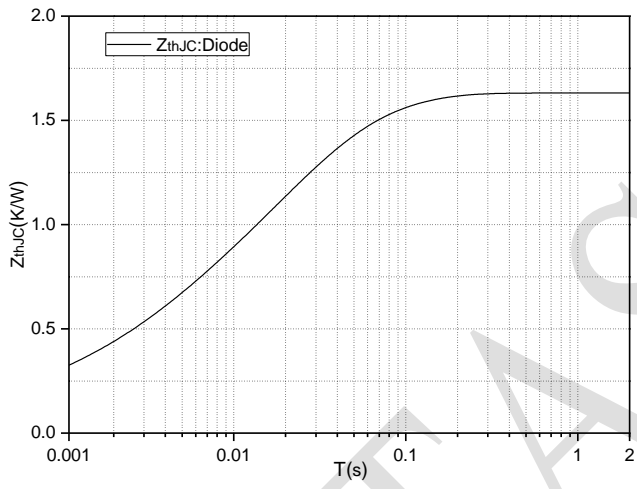
Fig.6 Typical Switching Loss vs. Gate Resistance



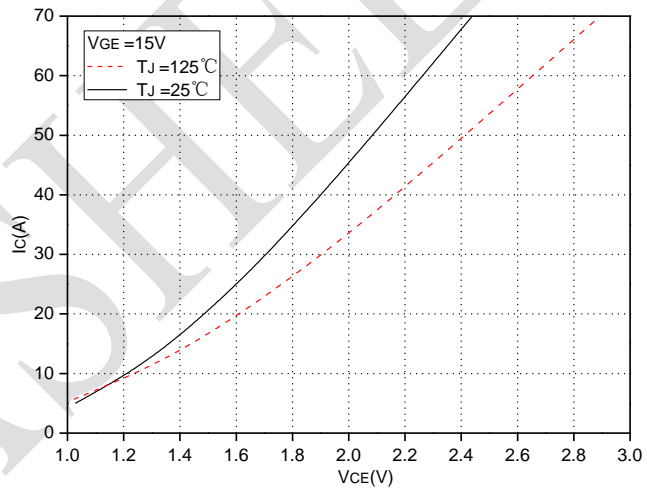
**Fig.7 Typical Load Current vs. Frequency**



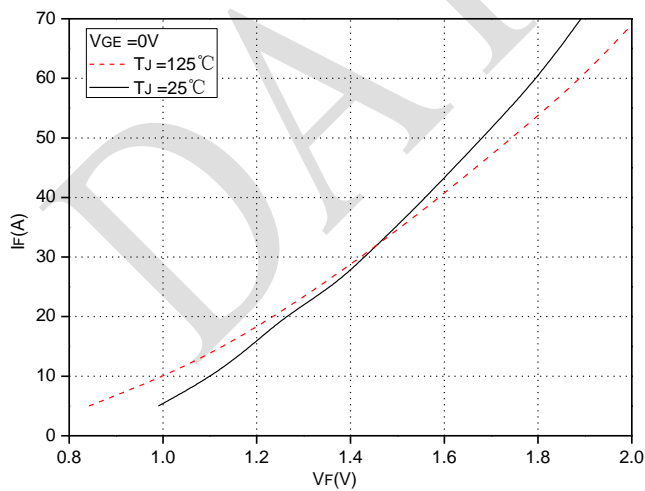
**Fig.8 Transient Thermal Impedance (IGBT)**



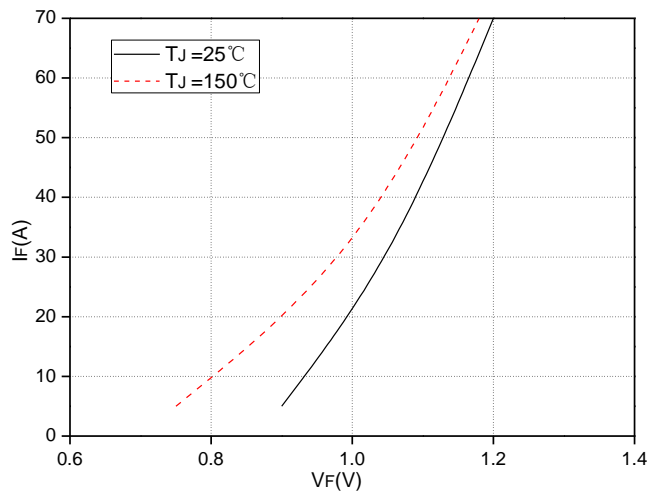
**Fig.9 Transient Thermal Impedance (Diode)**



**Fig.10 Typical Saturation Voltage Characteristics (Brake-Chopper)**



**Fig.11 Forward Characteristics of FWD (Brake-Chopper)**



**Fig.12 Forward Characteristics of Diode (Rectifier)**



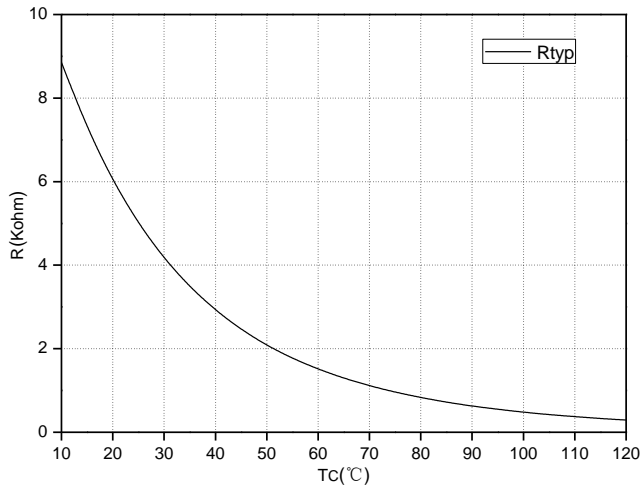


Fig.13 NTC Temperature Characteristics

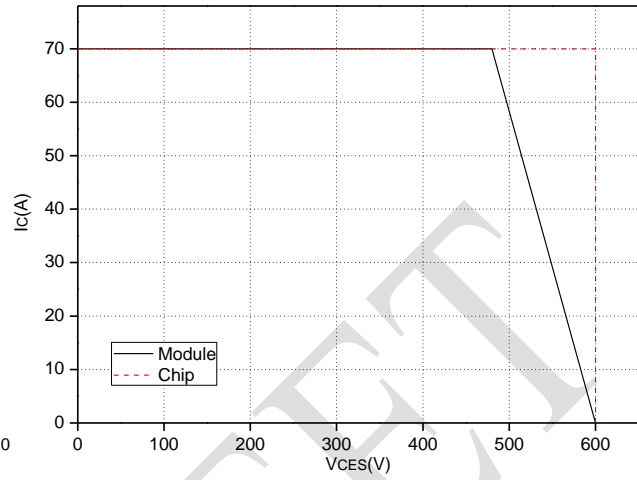
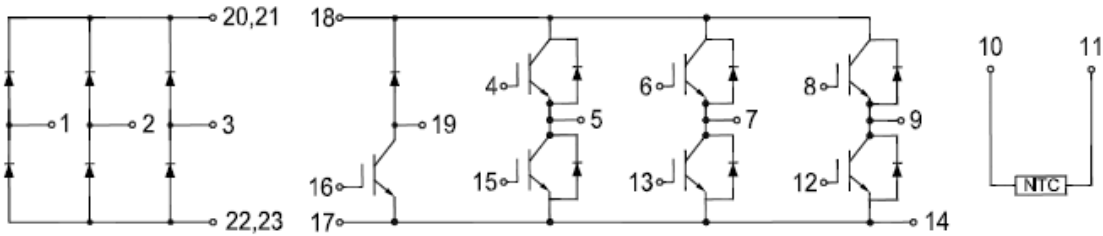


Fig.14 Reverse Bias Safe Operation Area (RBSOA)

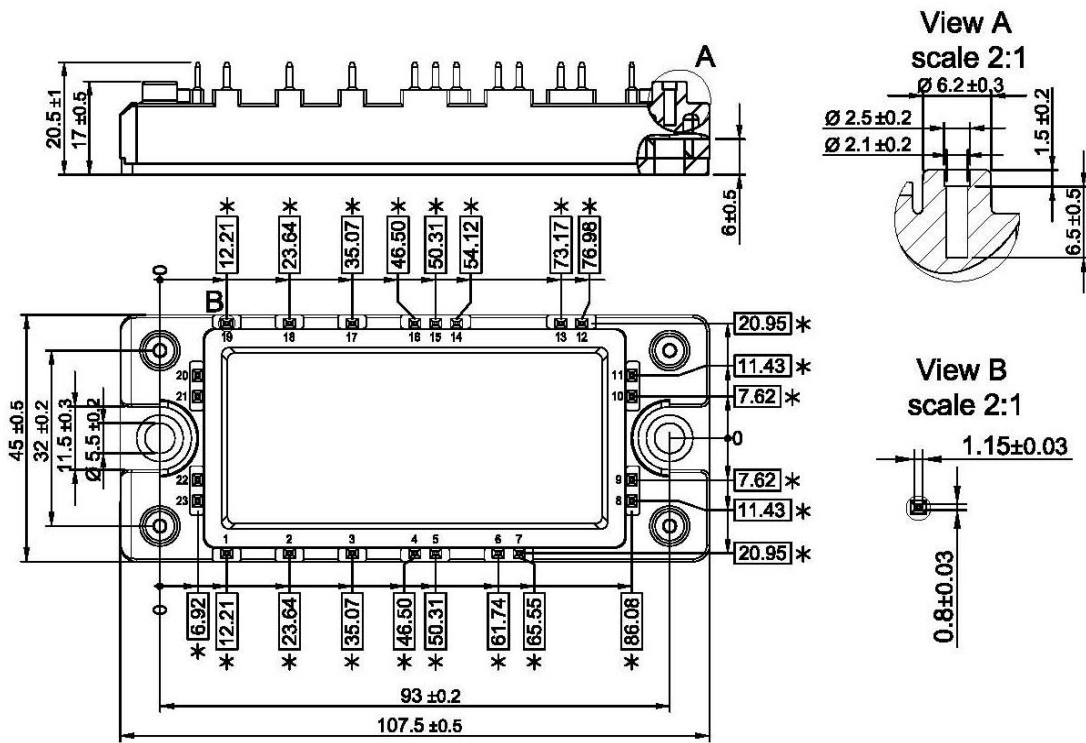
DATA SHEET



**Internal Circuit:**



**Package Outline (Unit: mm):**



\*=all dimensions with tolerance of  $\varnothing 0.4$



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DATA SHEET